

Low-Power, Slew-Rate-Limited RS-485/RS-422 Transceivers

Description

The HT6506 is low-power transceivers for RS-485 and RS- 422 communication. IC contains one driver and one receiver. The driver slew rates of the HT6506 is not limited, allowing them to transmit up to 10Mbps.

These transceivers draw between 120µA and 500µA of supply current when unloaded or fully loaded with disabled drivers. All parts operate from a single 3.3V supply. Drivers are short-circuit current limited and are protected against excessive power dissipation by thermal shutdown circuitry that places the driver outputs into a high-impedance state. The receiver input has a fail-safe feature that guarantees a logic-high output if the input is open circuit.



Features

- Low Quiescent Current: 120µA
- -7V to +12V Common-Mode Input Voltage Range
- Three-State Outputs
- 80ns Propagation Delays, 5ns Skew
- Half-Duplex Versions Available
- Operate from a Single 3.3V Supply
- Allows up to 32 Transceivers on the Bus
- Data rate: 10 Mbps
- Current-Limiting and Thermal Shutdown for Driver Overload Protection
- Enhanced ESD Specifications:
 - ±15kV IEC61000-4-2 Air Discharge

±8kV IEC61000-4-2 Contact Discharge

Pin Description



ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V _{CC}) 7V	Continuous Power Dissipation (T_A = +70°C)
Control Input Voltage -0.3V to 7V	8-Pin Plastic DIP (derate 9.09mW/°C above +70°C) 727mW
Driver Input Voltage (DI) -0.3V to 7V	8-Pin SOP (derate 5.88mW/°C above +70°C) 471mW
Driver Output Voltage (A, B) -7.5V to +12.5V	Operating Temperature Ranges -40°C to +85°C
Receiver Input Voltage (A, B) -7.5V to +12.5V	Storage Temperature Range -65°C to +160°C
Receiver Output Voltage (RO) -0.3V to (V _{CC} +0.3V)	Lead Temperature (soldering, 10sec) +300°C

* Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(V_{CC} = $3.3V \pm 0.3V$, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITION	IS	MIN	TYP	MAX	UNITS
Differential Driver Output (no load)	Vod1					3	V
Differential Driver Output	Vod2	R = 100Ω (RS-422)		1			V
(with load)		R = 54Ω (RS-485),	Figure 4	0.8			
Change in Magnitude of Driver Differential Output Voltage for Complementary Output States	ΔV od	R = 54Ω or 50Ω, Fig	gure 4			0.2	V
Driver Common-Mode Output Voltage	Voc	R = 54Ω or 100Ω, F	igure 4			2	V
Change in Magnitude of Driver Common-Mode Output Voltage for Complementary Output States	∆Voc	R = 54Ω or 100Ω, Figure 4				0.2	V
Input High Voltage	VIH	DE, DI, RE		2.0			V
Input Low Voltage	VIL	DE, DI, RE				0.8	V
Input Current	lin1	DE, DI, RE				±2	μA
Input Current	lin2	DE = 0V;	VIN = 12V			1.0	mA
(A, B)		Vcc = 0V or 3.35V	V _{IN} = -7V			-0.8	1
Receiver Differential Threshold Voltage	Vth	-7V ≤ V _{CM} ≤12V		-0.2		0.2	V
Receiver Input Hysteresis	ΔV th	Vcm = 0V			70		mV
Receiver Output High Voltage	Vон	lo = -1.5mA, VID = 200mV		2.5			V
Receiver Output Low Voltage	Vol	lo = 2.5mA, VID = -200mV				0.4	V
Three-State (high impedance) Output Current at Receiver	lozr	$0.4V \le V_0 \le 2.4V$				±1	μA
Receiver Input Resistance	RIN	$-7V \le V_{CM} \le 12V$	-7V ≤ V _{CM} ≤ 12V				kΩ



DC ELECTRICAL CHARACTERISTICS (continued)

(Vcc = $3.3V \pm 0.3V$, T_A = T_{MIN} to T_{MAX}, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
No-Load Supply Current	lcc	DE = V _{CC}		500	800	
(Note 3)		RE = 0V or Vcc		300	400	μA
		DE = 0V				
Driver Short-Circuit Current,	IOSD1	-7V ≤ Vo ≤ 12V (Note 4)			250	mA
Vo = High	losd2					
Driver Short-Circuit Current		-7V ≤ Vo ≤12V (Note 4)			250	mA
Vo = Low						
Receiver Short-Circuit Current	losr	$0V \le V_0 \le V_{CC}$	±6.5		95	mA
ESD Protection		A, B, Y and Z pins, tested using Human Body Model		±15		kV

SWITCHING CHARACTERISTICS

 $(V_{CC} = 3.3V \pm 0.3V, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
Driver Input to Output	t PLH	$R_{DIFF} = 54\Omega$	10	80	100	ns
	t PHL	C _{L1} = C _{L2} = 100pF	10	80	100	
Driver Output Skew to Output	tskew	R _{DIFF} = 54Ω, CL1 = CL2 = 100pF		5	10	ns
Driver Enable to Output High	tzн	C∟= 100pF, S2 closed		55	80	ns
Driver Enable to Output Low	tz∟	C∟= 100pF, S1 closed		55	80	ns
Driver Disable Time from Low	t∟z	C∟= 15pF, S1 closed		60	90	ns
Driver Disable Time from High	tнz	C∟= 15pF, S2 closed		60	90	ns
t _{PLH} - t _{PHL} Differential	t skd	R_{DIFF} = 54 Ω		13	20	ns
Receiver Input to Output	t _{PLH}	$R_{DIFF} = 54\Omega$	20	120	200	ns
	t _{PHL}	$C_{L1} = C_{L2} = 100 pF$	20	120	200	
Receiver Skew t _{PLH} - t _{PHL}		C _{L1} = C _{L2} = 100pF		5	10	
Receiver Enable to Output Low	tzL	C _{RL} = 15pF, S1 closed		50	90	ns
Receiver Enable to Output High	tzн	C _{RL} = 15pF, S2 closed		50	90	ns
Receiver Disable Time from	t∟z	C _{RL} = 15pF, S1 closed		40	80	ns
Low						
Receiver Disable Time from	tнz	C _{RL} = 15pF, S2 closed		40	80	ns
High						
Maximum Data Rate	fмах		2.5	5	10	Mbps

Note 1: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

Note 2: All typical specifications are given for V_{CC} =3.3V and T_A=+25°C.

Note 3: Supply current specification is valid for loaded transmitters when DE=0V.

Note 4: Applies to peak current.



TEST CIRCUITS





Figure 1. Driver V_{OD} and V_{OC}

Figure 2. Driver V_{OD} with Varying Common-Mode Voltage



Figure 3. Receiver V_{OH} and V_{OL}



Figure 4. Driver Differential Output Delay and Transition Times



TEST CIRCUITS (continue)







Figure 6. Driver Enable and Disable Times (t_{PZH}, t_{PSH}, t_{PHZ})



Figure 7. Driver Enable and Disable Times ($t_{\text{PZL}},\,t_{\text{PSL}},\,t_{\text{PLZ}})$



TEST CIRCUITS (continue)



Figure 8. Receiver Propagation Delay



Figure 9. Receiver Enable and Disable Times

Note 5: The input pulse is supplied by a generator with the following characteristics: PRR = 250kHz, 50% duty cycle, tr \leq 6.0ns, Z₀ = 50 Ω . **Note 6:** C_L includes probe and stray capacitance.



Function Tables

Transmitting						
I	NPUTS		OUTP	UTS X		
RE	DE	DI	Z	Y		
Х	1	1	0	1		
Х	1	0	1	0		
0	0	Х	Z	Z		
1	0	Х	Z	Z		

Receiving						
	INPU ⁻	OUTPUTS				
RE	DE	A-B	RO			
0	0	+0.2V	1			
0	0	-0.2V	0			
0	0	open	1			
1	0	Х	Z			

X-don't care Z-high impedance

Typical Information



Figure 10. HT6506 Typical RS-485 Network

Driver Output Protection

Excessive output current and power dissipation caused by faults or by bus contention are prevented by two mechanisms. A foldback current limit on the output stage provides immediate protection against short circuits over the whole common-mode voltage range. In addition, a thermal shutdown circuit forces the driver outputs into a high-impedance state if the die temperature rises excessively.

Propagation Delay

Skew time is simply the difference between the low-to-high and high-to-low propagation delay. Small driver/receiver skew times help maintain a symmetrical mark-space ratio (50% duty cycle). The receiver skew time, $|t_{PRLH} - t_{PRHL}|$, is under 10ns. The driver skew times are 5ns for the HT6506.

Typical Applications

HT6506 transceivers are designed for bidirectional data communications on multipoint bus transmission lines. Figure 10 shows typical network applications circuits. These parts can also be used as line repeaters, with cable lengths longer than 4000 feet.

To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible.





(DIP8)



	Dimension, mm			
Symbol	MIN MAX			
А	8.51 10.16			
В	6.1 7.11			
С		5.33		
D	0.36 0.56			
F	1.14 1.78			
G	2.54			
Н	7.62			
J	0°	10°		
K	2.92 3.81			
L	7.62 8.26			
М	0.2 0.36			
Ν	0.38			

NOTES:

 Dimensions "A", "B" do not include mold flash or protrusions. Maximum mold flash or protrusions 0.25 mm (0.010) per side.

⊕ 0.25 (0.010) ∭ T

-T- SEATING PLANE

Μ

B ↓

(SOP8)	



	Dimension, mm			
Symbol	MIN MAX			
А	4.8 5			
В	3.8 4			
С	1.35 1.75			
D	0.33 0.51			
F	0.4 1.27			
G	1.27			
Н	5.72			
J	0° 8°			
K	0.1 0.25			
М	0.19 0.25			
Р	5.8 6.2			
R	0.25 0.5			



NOTES:

- $1. \ \ \, Dimensions\ A\ and\ B\ do\ not\ include\ mold\ flash\ or\ protrusion.$
- 2. Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B 0.25 mm (0.010) per side.

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